

Complete embedded, wireless development platform based on the NXP i.MX 93 with AI/ML NPU, designed for longevity and scalability in industrial IoT applications

The **Digi ConnectCore' 93 Development Kit** features a tightly integrated, secure, industrial-specified system-on-module (SOM) platform, based on the NXP^o i.MX 93 application processor, with Wi-Fi 6 and Bluetooth^o 5.2 wireless connectivity.

The kit supports development of a wide range of medical, industrial, energy, and transportation applications, including Internet of Things (IoT), automation, human-machine interface (HMI), equipment monitoring, audio/voice, edge computing and machine learning (e.g. anomaly detection).

Digi ConnectCore 93 features up to two power-efficient Arm[®] Cortex[®]-A55 cores, with a Cortex-M33 core, AI/ML Arm Ethos U65 NPU and NXP PMIC for maximum power efficiency. This SOM is designed for industrial reliability and 10+ year product lifecycles. **Digi ConnectCore Cloud Services, Digi ConnectCore Security Services** and **Expert Support** provide additional capabilities for development, deployment and maintenance.

The ConnectCore SOM solution provides ready-to-use building blocks, a complete, embedded Linux software platform based on the Yocto[®] Project, and development tools. This helps OEMs lower research and development costs, realize a lower total cost of ownership, and streamline time-to-market.

Embedded device security is a critical design aspect for the growing number of connected IoT applications. **Digi ConnectCore SOM solutions** provide built-in security with **Digi TrustFence**[•], a fully integrated device-security framework simplifying the process of securing connected devices.

With twenty years of embedded SOM experience enabling millions of globally connected products, Digi is a trusted embedded and IoT solutions provider, simplifying the way customers design, build and deploy connected applications. **Digi Wireless Design Services** (WDS) offer additional support, certification assistance, and custom design services to get your products to market smarter and faster.



Connect this device with Digi ConnectCore Cloud Services. Create. Configure. Deploy. Manage.

The kit includes:

- ✓ Digi ConnectCore 93 development board with SOM
- ✓ Console port cable
- ✓ Dual-band wireless antenna
- ✓ Power supply and accessories
- \checkmark Reference designs and online documentation

PART NUMBER	DESCRIPTION
CC-WMX93-KIT	Digi ConnectCore 93 Development Kit

Key features, benefits and applications

- Industrial i.MX 93 dual-core embedded SOM platform
- AI/ML Arm Ethos U65 micro neural processing unit (NPU)
- Pre-certified dual-band 802.11ax Wi-Fi 6 and Bluetooth 5.2
- Digi SMTplus[®] form factor (40 x 45 mm) for ultimate reliability
- Superior power management, hardware and software support
- Seamless cellular modem and Digi XBee° integration
- High level of pin-compatibility with Digi ConnectCore 8 SOMs
- Built-in **Digi TrustFence** device security, identity and privacy
- Remote monitoring, device management and IoT application enablement with **Digi ConnectCore Cloud Services**
- Digi Embedded Yocto Linux support
- Turnkey development services available from Digi WDS



DIGI CONNECTCORE 93 DEVELOPMENT KIT

Specifications

SPECIFICATIONS	DIGI CONNECTCORE 93 SOM	
APPLICATION PROCESSOR	 NXP i.MX 93 Up to 2x Cortex-A55 cores at 1.7 GHz 1x Cortex-M33 core at 250 MHz core for real-time processing 	
MEMORY	Up to 32 GB flash (eMMC), up to 2 GB of LPDDR4 / LPDDR4X (16-bit)	
NPU	AI/ML Arm Ethos U65 micro neural processor	
PMIC	NXP PCA9451	
GRAPHICS / DISPLAY	2D GPU: Blended/composition, resize, color space conversion 1x 1080p 60 MIPI DSI (4-lane, 1.5 Gbps/lane) with PHY 1x 720p 60 LVDS (4-lane) 18-bit parallel RGB	
CAMERA	1x 1080p 60 MIPI-CSI (2-lane, 1.5 Gbps/lane) with PHY 8-bit parallel YUV/RGB	
SECURITY	Digi TrustFence : secure boot, filesystem encryption, tamper detection, secure JTAG, secure console, secure build environments, secure firmware updates; EdgeLock secure enclave: crypto, tamper detection, secure clock, secure boot, eFuse key storage, random number; Arm TrustZone (Cortex-A and Cortex-M)	
PERIPHERALS/ INTERFACES	 2x USB 2.0 OTG controllers with integrated PHY interfaces 1x Ultra Secure Digital Host Controller (uSDHC) interfaces 8x Low Power Universal Asynchronous Receiver / Transmitter (LPUART) modules 8x Low Power I2C modules, 2x I3C 8x Low Power SPI (LPSPI) modules 2x FlexCAN with flexible data-rate (FD) support 4x pulse-width modulator (PWM) with 16-bit counter 1x 12-bit ADC module with accurate internal voltage reference, up to 4 channels 3x Synchronous Audio Interface (SAI) modules (up to 4 lanes) supporting I2S, AC97, TDM, codec/DSP and DSD interfaces 1x S/PDIF input and output, including a raw capture input mode 8-channel Pulse Density Modulation (PDM) input Up to 112 GPIOs 	
ETHERNET	2x 10/100/1000M Ethernet with EEE, AVB and IEEE 1588 (1x TSN)	
WI-FI	Wi-Fi 6 802.11ax dual-band 1x1 wireless	
BLUETOOTH	Bluetooth 5.2	
802.15.4	802.15.4 (optional)	
ON-MODULE MICROCONTROLLER ASSIST	Digi Microcontroller Assist [™] for advanced power management, security, peripheral support and system reliability (optional) • Independent Cortex-M0+ microcontroller subsystem • Supporting ultra-low power modes	
OPERATING TEMPERATURE	Industrial: -40 °C to 85 °C (-40 °F to 185 °F), depending on use case and enclosure/system design	
STORAGE TEMPERATURE	-50 °C to 125 °C (-58 °F to 257 °F)	
RELATIVE HUMIDITY	5% to 90% (non-condensing)	
RADIO APPROVALS	US, Canada, EU, Japan, Australia/New Zealand, Brazil, Mexico	
EMISSIONS/ IMMUNITY/ SAFETY	FCC Part 15 Class B, EN 55022 Class B, EN 61000-3-2, EN 61000-3-3, ICES- 003 Class B, VCCI Class II, AS 3548, FCC Part 15 Subpart C Section 15.247, IC (Industry Canada), RSS-210 Issue 5 Section 6.2.2(o), EN 300 328, EN 301 489-17, EN 55024, EN 301 489-3, Safety (IEC 62368-1); visit www.digi.com/resources/certifications for latest updates	
DESIGN VERIFICATION	Temperature: IEC 60068-2-1, IEC 60068-2-2, IEC 60068-2-78 Vibration/shock: IEC 60068-2-6, IEC 60068-2-64, IEC 60068-2-27, HALT	
MECHANICAL DIMENSIONS	118 castellated vias, LGA-474, 1.27 mm pitch, 40 mm x 45 mm x 3.5 mm (1.6 in x 1.8 in x 0.1 in)	
PRODUCT WARRANTY	3-year	





DIGI CONNECTCORE 93 DEVELOPMENT KIT

Part Numbers

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DIGI CONNECTCORE 93 DEVELOPMENT KIT

CC-WMX93-KIT

Digi ConnectCore 93 Development Kit with development board , i.MX 93 dual-core, NPU, 8GB eMMC, 1 GB LPDDR4 wireless SOM

PART NUMBERS	DIGI CONNECTCORE CLOUD SERVICES
CC-CS-ESS-1-1YR	Digi ConnectCore Cloud Services — Essential 1-year (1 device)
CC-CS-ESS-100-1YR	Digi ConnectCore Cloud Services — Essential 1-year (100 devices)
CC-CS-ESS-100-3YR	Digi ConnectCore Cloud Services — Essential 3-year (100 devices)
CC-CS-ESS-100-5YR	Digi ConnectCore Cloud Services — Essential 5-year (100 devices)
CC-CS-PRM-1-1YR	Digi ConnectCore Cloud Services — Premium 1-year (1 device)
CC-CS-PRM-100-1YR	Digi ConnectCore Cloud Services — Premium 1-year (100 devices)
CC-CS-PRM-100-3YR	Digi ConnectCore Cloud Services — Premium 3-year (100 devices)
CC-CS-PRM-100-5YR	Digi ConnectCore Cloud Services — Premium 5-year (100 devices)

PART NUMBERS	DIGI CONNECTCORE SECURITY SERVICES
CC-SEC-ESS	Digi ConnectCore Security Services — Essential 1-year
CC-SEC-PRM	Digi ConnectCore Security Services — Premium 1-year
CC-SEC-ENT	Digi ConnectCore Security Services — Enterprise 1-year
CC-SEC-ENT-ADD	Digi ConnectCore Security Services — Additional product (same duration as main contract)

PART NUMBERS	EXPERT SUPPORT
DG-EXPE-12	Expert 12x5 support for end users
DG-EXPE-24	Expert 24x7 support for end users















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For more information, please visit digi.com

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For more information about Digi ConnectCore, visit www.digi.com/connectcore

